



Vincotech

flowBOOST 1 symmetric dual		1200 V / 40 A
Features		flow 1 12 mm housing
<ul style="list-style-type: none">• Symmetric Boost for 1500 Vdc applications• Latest IGBT technology for high speed frequencies• Low inductance package• Integrated NTC• Cost effective alternative to L869L08• Same package and pin-out as L869L08		
Target applications		Schematic
<ul style="list-style-type: none">• Solar Inverters		
Types		
<ul style="list-style-type: none">• 10-FY12S2A040N3-L868L28		



10-FY12S2A040N3-L868L28

datasheet

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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	42	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	160	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	95	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	28	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	92	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 8,3 \text{ ms}$ $T_j = 150^\circ\text{C}$	66	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	87	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	25	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	200	A
Surge current capability	I^2t		200	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	37	W
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
ByPass Diode				
Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	38	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$	270	A
Surge current capability	P_t	$T_j = 150^\circ\text{C}$	370	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	47	W
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance				9,6	mm
Comparative Tracking Index	CTI			≥ 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0004	25	4,5	5,5	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		40	25 125 150		1,89 2,06 2,13	1,95 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			400	µA
Gate-emitter leakage current	I_{GES}		20	0		25			200	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{res}	$f = 1 \text{ MHz}$	0	20	25			4912		pF
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		15	600	40	25		212		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	0/15	700	40	25		34,88		
Rise time	t_r					125		32,64		ns
						150		32		
Turn-off delay time	$t_{d(off)}$					25		18,72		
						125		19,52		
Fall time	t_f					150		20,16		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD}=0,127 \mu\text{C}$ $Q_{fFWD}=0,126 \mu\text{C}$ $Q_{tFWD}=0,126 \mu\text{C}$				25		213,28		
						125		245,6		
						150		252,96		ns
Turn-off energy (per pulse)	E_{off}					25		56,21		
						125		79,28		
						150		88,85		ns
						25		0,78		
						125		0,838		
						150		0,874		mWs
						25		1,13		
						125		1,88		
						150		2,12		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Diode

Static

Forward voltage	V_F				20	25 125 150		1,43 1,74 1,84	1,6 ⁽¹⁾	V
Reverse leakage current	I_R	$V_F = 1200$ V			25 150		20 160	400	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,09		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=2319$ A/ μ s $di/dt=2320$ A/ μ s $di/dt=2197$ A/ μ s	0/15	700	40	25 125 150		13,08 13,27 13,3		A
Reverse recovery time	t_{rr}					25 125 150		14,71 14,4 14,33		ns
Recovered charge	Q_r					25 125 150		0,127 0,126 0,126		μ C
Reverse recovered energy	E_{rec}		700	40	25 125 150		0,036 0,035 0,037		mWs	
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$				25 125 150		2358 2371 2431		A/μ s	



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Sw. Protection Diode

Static

Forward voltage	V_F				18	25 125 150		1,12 1,03 1,02			V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000		μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,87			K/W
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ByPass Diode

Static

Forward voltage	V_F				28	25 125		1,15 1,1			V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000		μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,5			K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

(1) Value at chip level

(2) Only valid with pre-applied Vincotech thermal interface material.



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Boost Switch Characteristics

figure 1. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

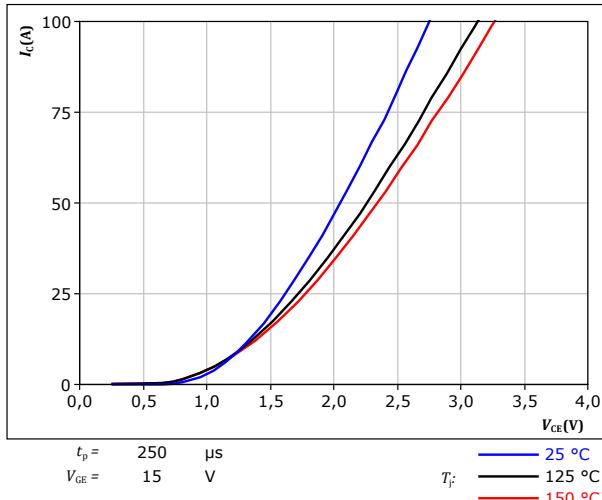


figure 3. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

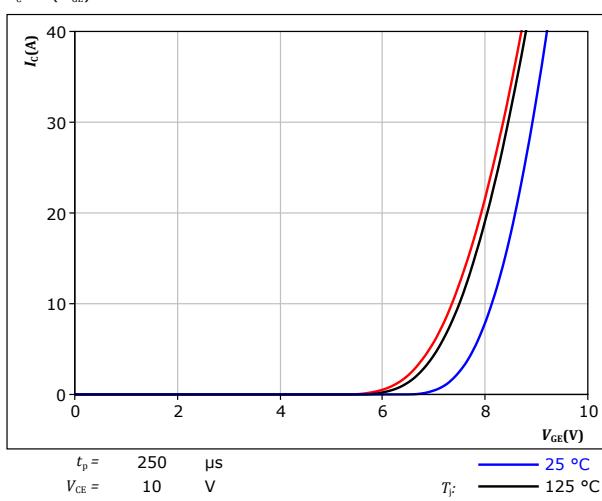


figure 2. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

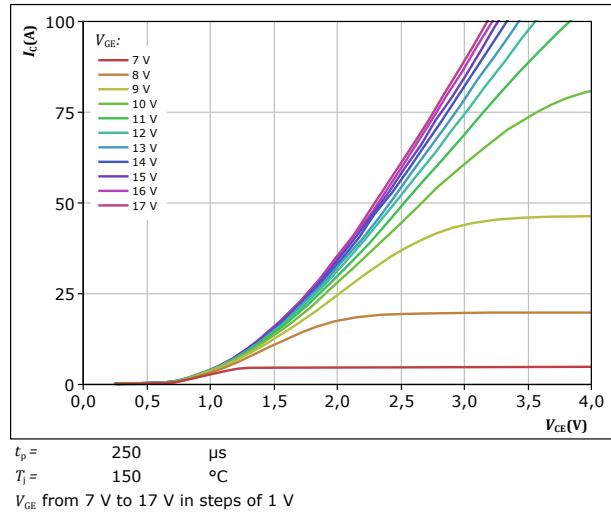
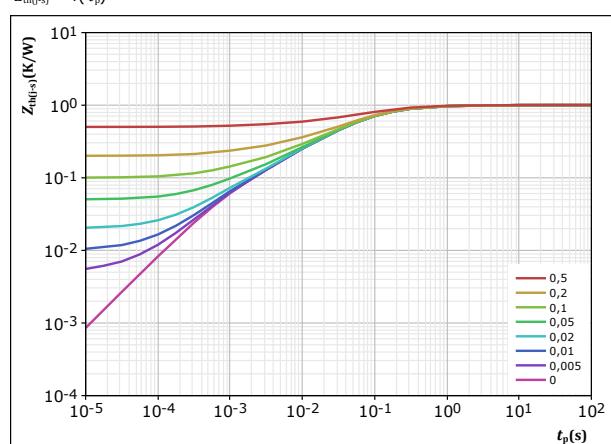


figure 4. IGBT

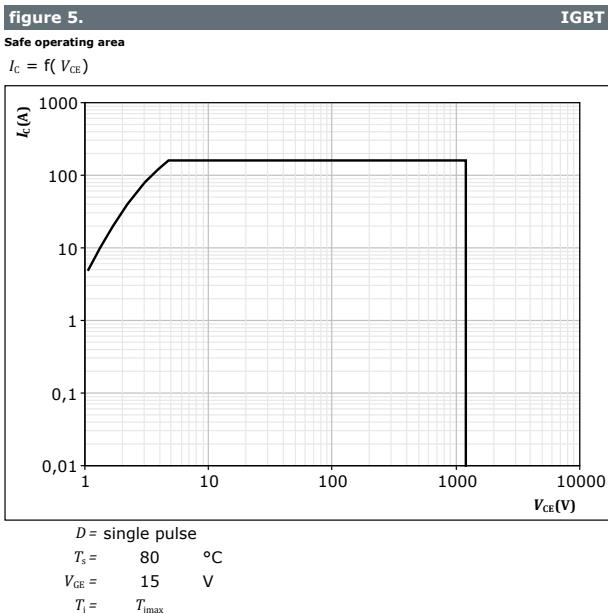
Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



$D =$	t_p / T	K/W
	$R_{th(j-s)} = 1,004$	$\tau (s)$
		IGBT thermal model values
R (K/W)		
4,18E-02		2,71E+00
2,29E-01		2,66E-01
5,09E-01		6,04E-02
1,75E-01		9,12E-03
4,98E-02		8,69E-04



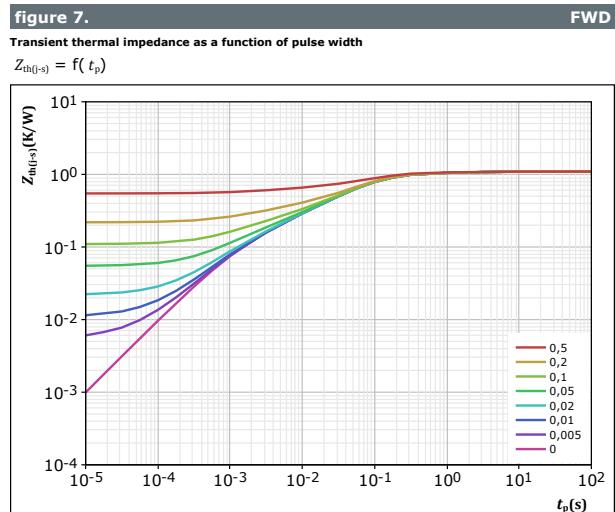
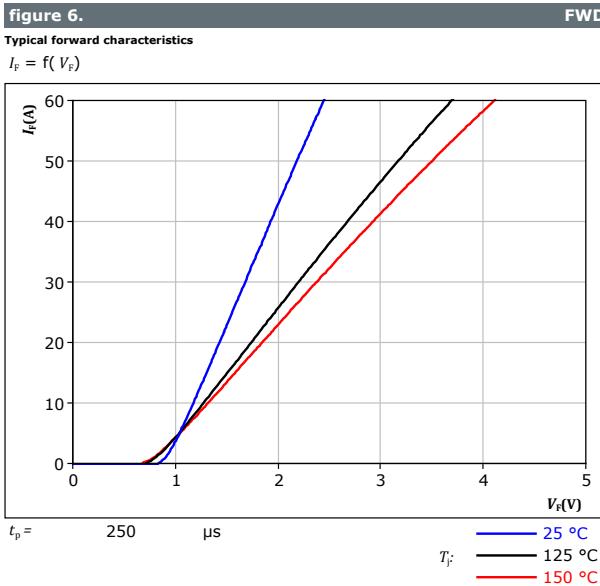
Boost Switch Characteristics





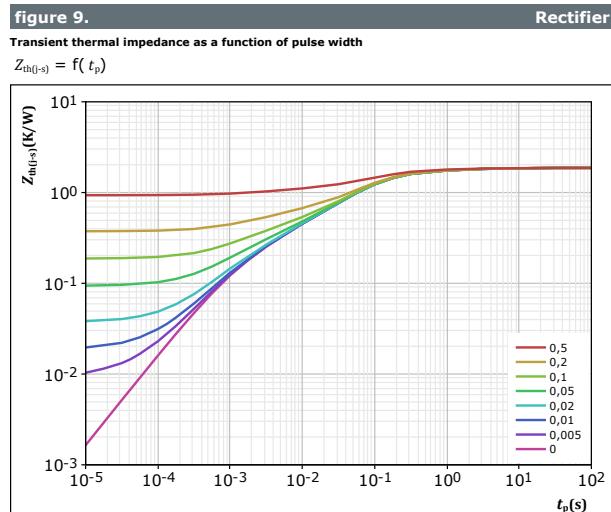
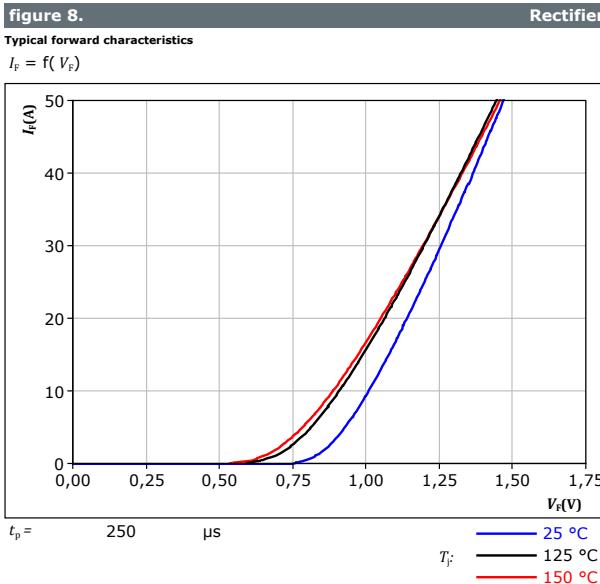
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Boost Diode Characteristics





Boost Sw. Protection Diode Characteristics





ByPass Diode Characteristics

figure 10.

Typical forward characteristics

$$I_F = f(V_F)$$

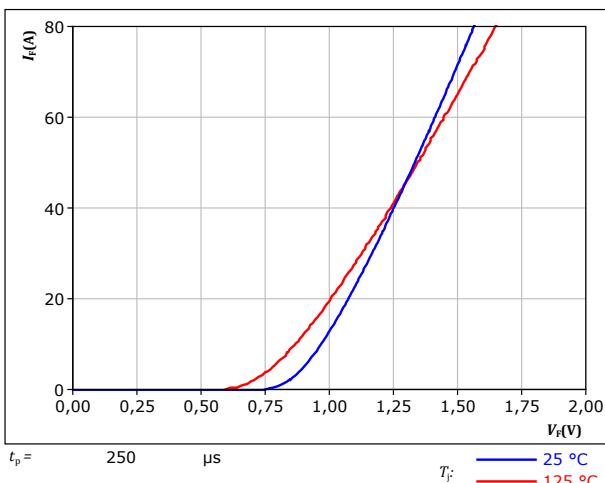
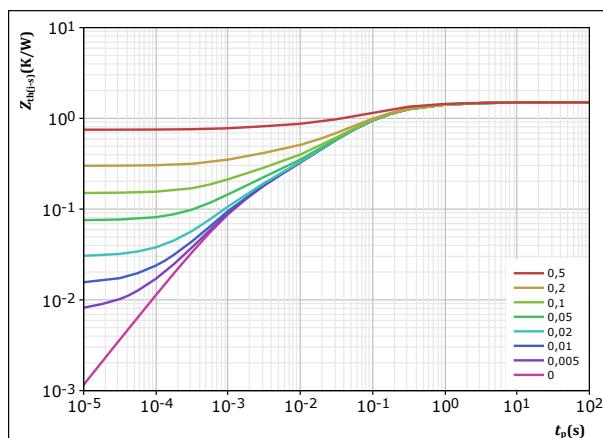


figure 11.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

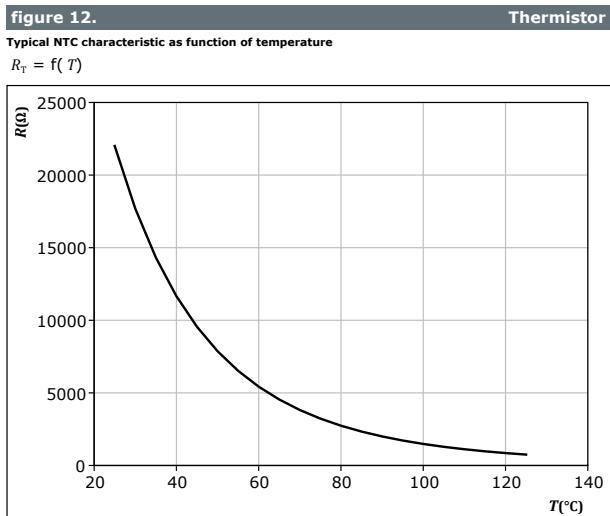


Rectifier thermal model values

R (K/W)	τ (s)
9,44E-02	2,48E+00
3,47E-01	3,51E-01
7,44E-01	7,63E-02
2,04E-01	1,21E-02
1,11E-01	1,25E-03



Thermistor Characteristics



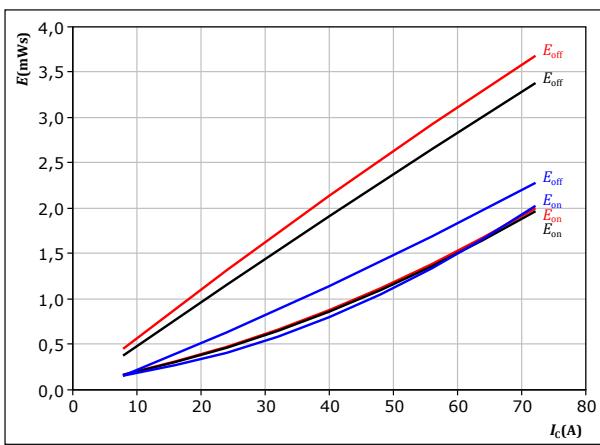


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Boost Switching Characteristics

figure 13.

Typical switching energy losses as a function of collector current
 $E = f(I_c)$



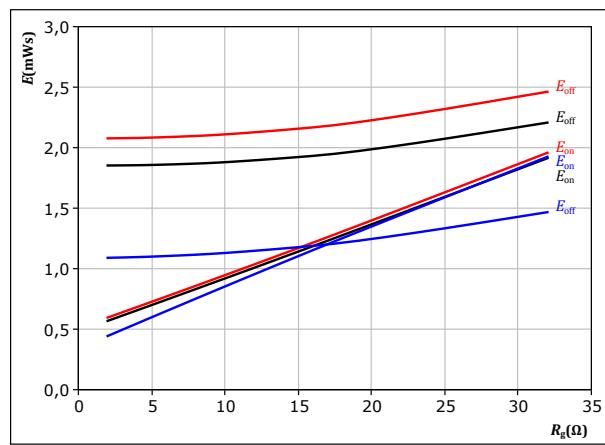
With an inductive load at

$V_{CE} = 700$ V $T_f = 125$ °C
 $V_{GE} = 0/15$ V $T_f = 150$ °C
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

IGBT

figure 14.

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$



With an inductive load at

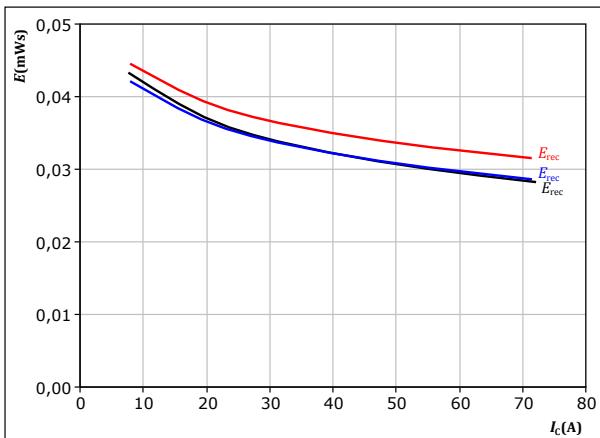
$V_{CE} = 700$ V $T_f = 125$ °C
 $V_{GE} = 0/15$ V $T_f = 150$ °C
 $I_c = 40$ A

IGBT

figure 15.

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_c)$



With an inductive load at

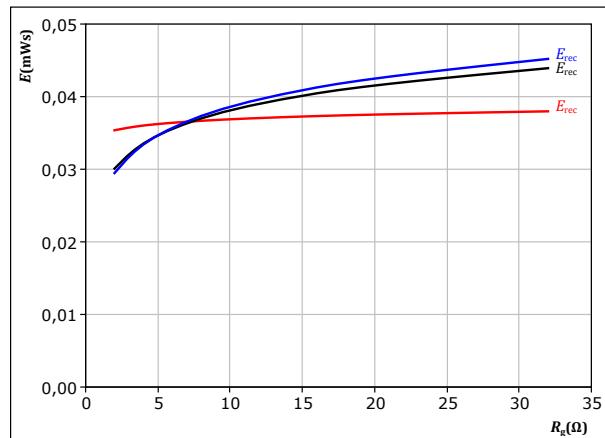
$V_{CE} = 700$ V $T_f = 125$ °C
 $V_{GE} = 0/15$ V $T_f = 150$ °C
 $R_{gon} = 8 \Omega$

FWD

figure 16.

Typical reverse recovered energy loss as a function of gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 700$ V $T_f = 125$ °C
 $V_{GE} = 0/15$ V $T_f = 150$ °C
 $I_c = 40$ A

FWD

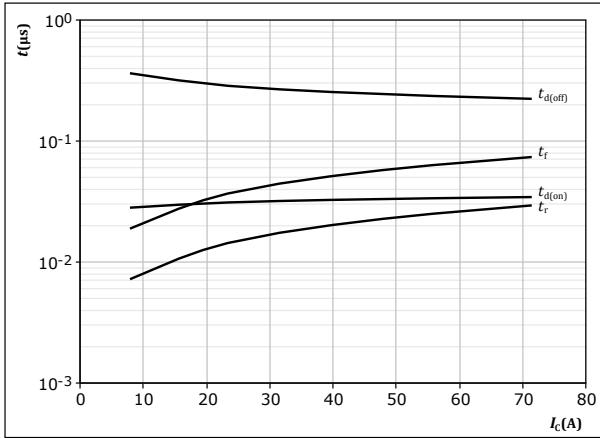


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Boost Switching Characteristics

figure 17. IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

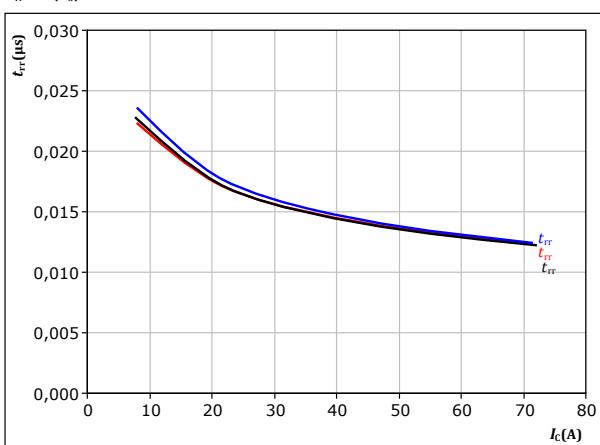


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

figure 19. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$

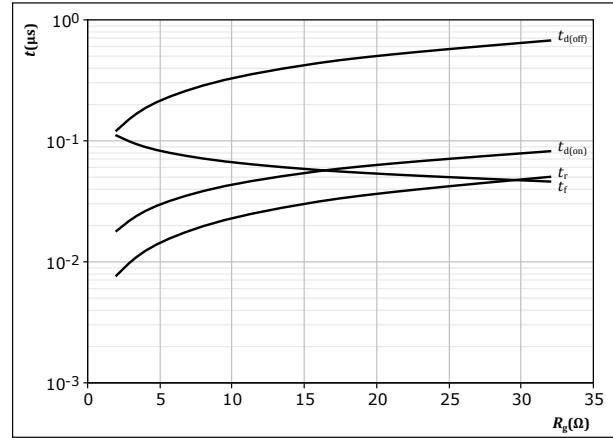


With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 8 \Omega$

figure 18. IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$

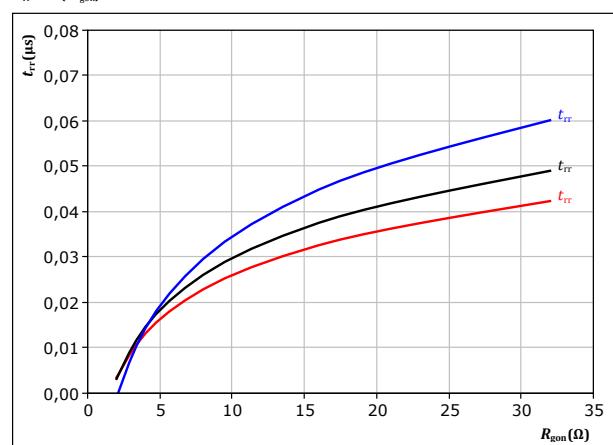


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 40 \text{ A}$

figure 20. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 40 \text{ A}$



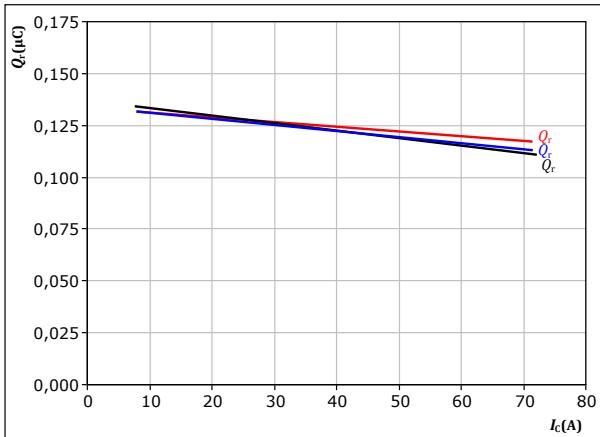
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Boost Switching Characteristics

figure 21.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

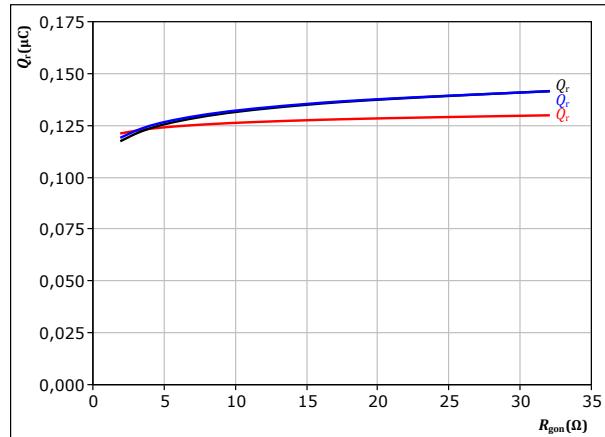
$$\begin{aligned} V_{CE} &= 700 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= 0/15 \text{ V} & & \\ R_{gon} &= 8 \Omega & & \end{aligned}$$

FWD

figure 22.

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

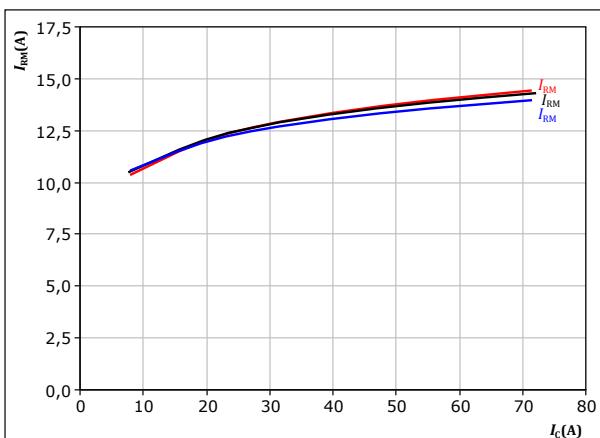
$$\begin{aligned} V_{CE} &= 700 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= 0/15 \text{ V} & & \\ I_c &= 40 \text{ A} & & \end{aligned}$$

FWD

figure 23.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

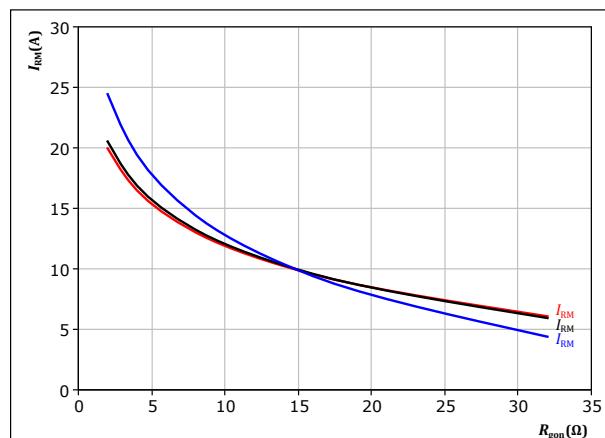
$$\begin{aligned} V_{CE} &= 700 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= 0/15 \text{ V} & & \\ R_{gon} &= 8 \Omega & & \end{aligned}$$

FWD

figure 24.

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} & T_f &= 125 \text{ °C} \\ V_{GE} &= 0/15 \text{ V} & & \\ I_c &= 40 \text{ A} & & \end{aligned}$$

FWD



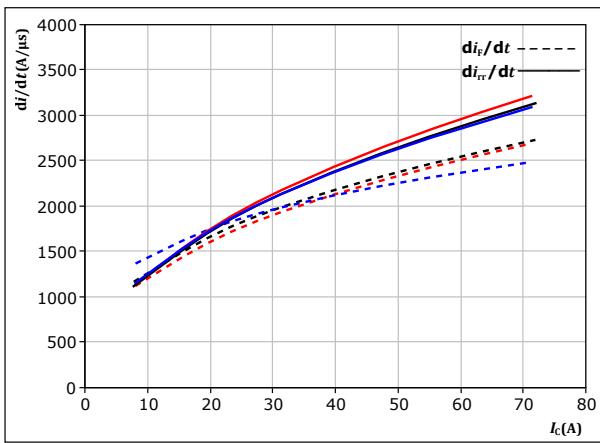
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Boost Switching Characteristics

figure 25. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

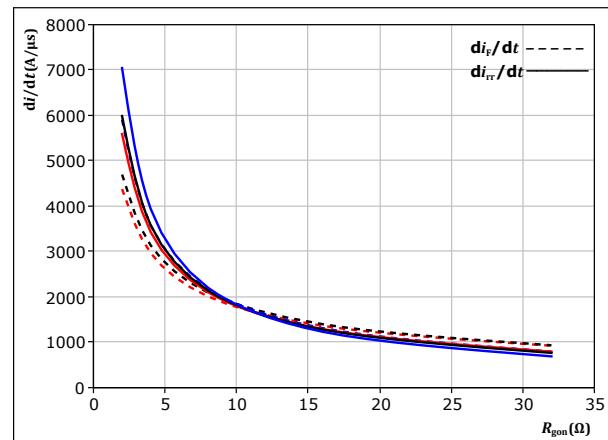
$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 8 \Omega$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 26. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

$di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

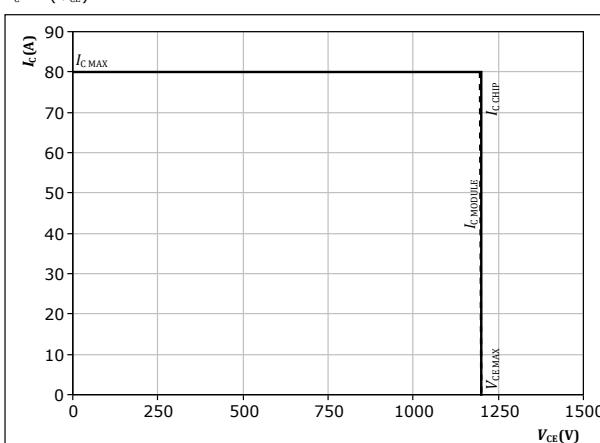
$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 40 \text{ A}$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 27. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150 \text{ }^\circ\text{C}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$



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Boost Switching Definitions

figure 28. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

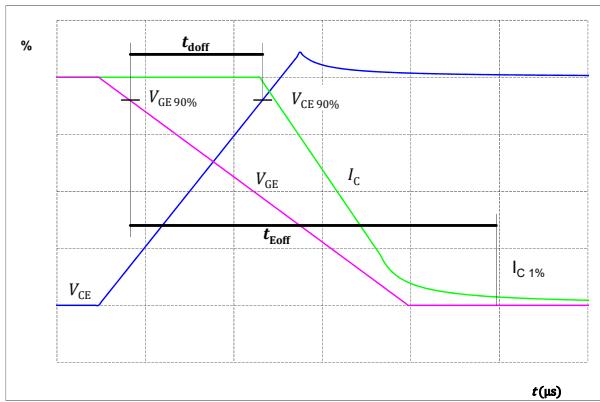


figure 29. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

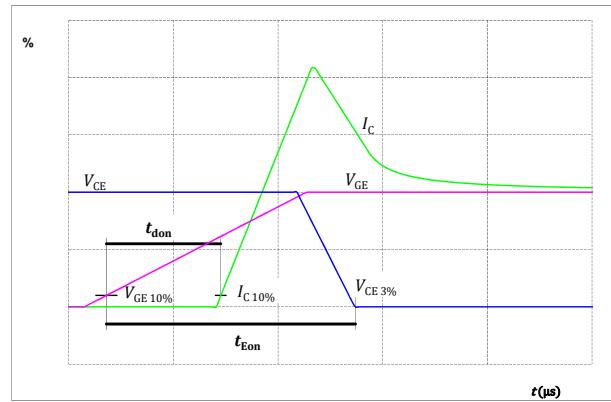


figure 30. IGBT

Turn-off Switching Waveforms & definition of t_f

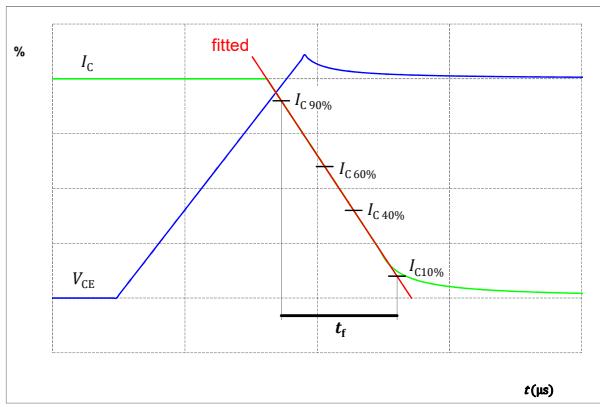
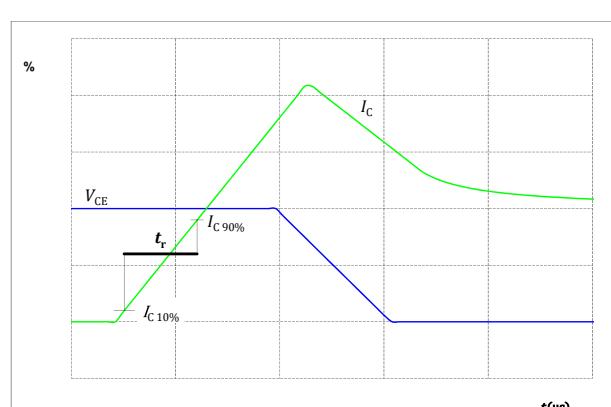


figure 31. IGBT

Turn-on Switching Waveforms & definition of t_r





Boost Switching Definitions

figure 32.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

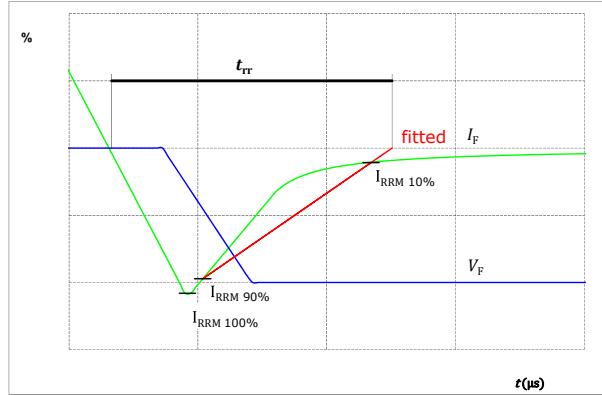
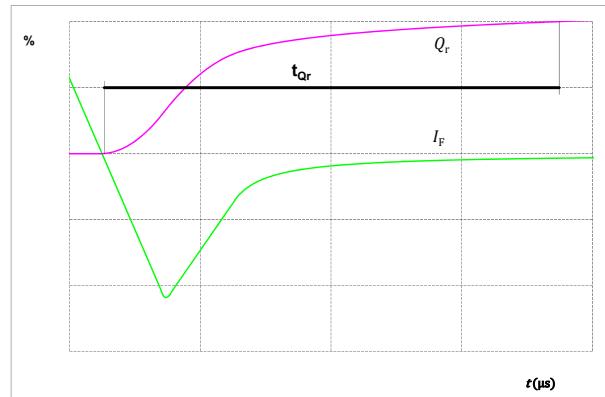


figure 33.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD

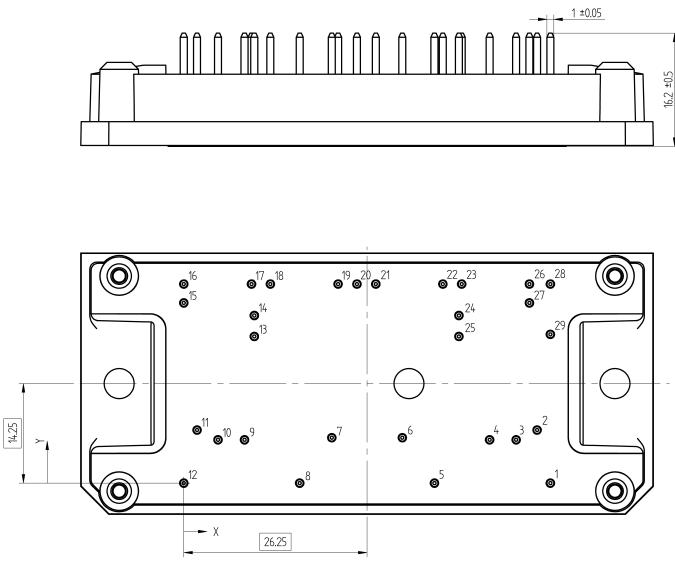
Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)



**10-FY12S2A040N3-L868L28**

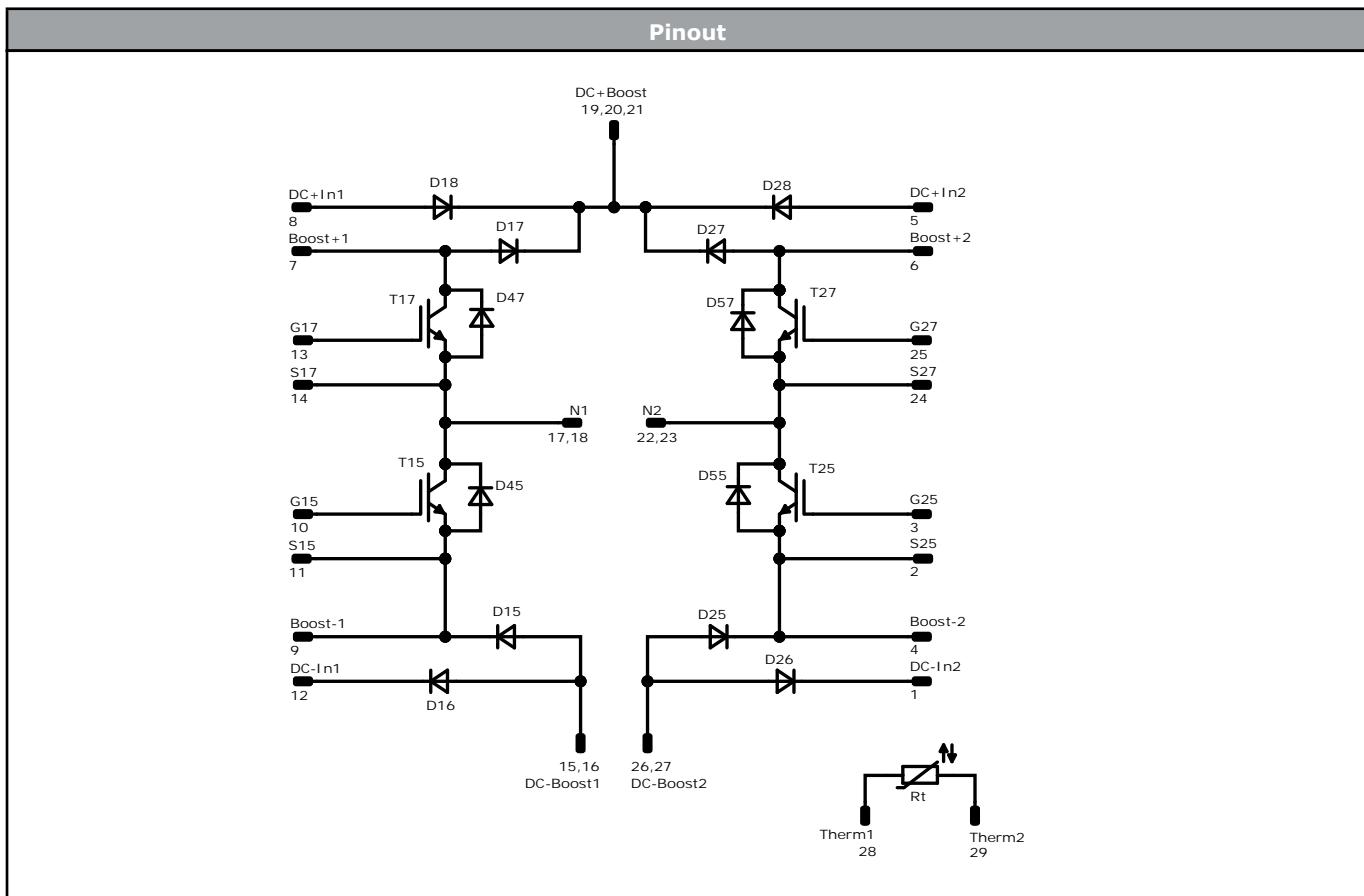
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Pin table [mm] <table border="1"><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr></thead><tbody><tr><td>1</td><td>52,5</td><td>0</td><td>DC-In2</td></tr><tr><td>2</td><td>50,6</td><td>7,6</td><td>S25</td></tr><tr><td>3</td><td>47,6</td><td>6,2</td><td>G25</td></tr><tr><td>4</td><td>43,8</td><td>6,2</td><td>Boost-2</td></tr><tr><td>5</td><td>35,9</td><td>0</td><td>DC+In2</td></tr><tr><td>6</td><td>31,3</td><td>6,5</td><td>Boost+2</td></tr><tr><td>7</td><td>21,2</td><td>6,5</td><td>Boost+1</td></tr><tr><td>8</td><td>16,6</td><td>0</td><td>DC+In1</td></tr><tr><td>9</td><td>8,7</td><td>6,2</td><td>Boost-1</td></tr><tr><td>10</td><td>4,9</td><td>6,2</td><td>G15</td></tr><tr><td>11</td><td>1,9</td><td>7,6</td><td>S15</td></tr><tr><td>12</td><td>0</td><td>0</td><td>DC-In1</td></tr><tr><td>13</td><td>10,1</td><td>21</td><td>G17</td></tr><tr><td>14</td><td>10,1</td><td>24</td><td>S17</td></tr><tr><td>15</td><td>0</td><td>25,8</td><td>DC- Boost1</td></tr><tr><td>16</td><td>0</td><td>28,5</td><td>DC- Boost1</td></tr><tr><td>17</td><td>9,7</td><td>28,5</td><td>N1</td></tr><tr><td>18</td><td>12,4</td><td>28,5</td><td>N1</td></tr><tr><td>19</td><td>22,1</td><td>28,5</td><td>DC+Boost</td></tr><tr><td>20</td><td>24,8</td><td>28,5</td><td>DC+Boost</td></tr><tr><td>21</td><td>27,5</td><td>28,5</td><td>DC+Boost</td></tr><tr><td>22</td><td>37,1</td><td>28,5</td><td>N2</td></tr><tr><td>23</td><td>39,8</td><td>28,5</td><td>N2</td></tr><tr><td>24</td><td>39,4</td><td>24</td><td>S27</td></tr><tr><td>25</td><td>39,4</td><td>21</td><td>G27</td></tr><tr><td>26</td><td>49,5</td><td>28,5</td><td>DC- Boost2</td></tr><tr><td>27</td><td>49,5</td><td>25,8</td><td>DC- Boost2</td></tr><tr><td>28</td><td>52,5</td><td>28,5</td><td>Therm1</td></tr><tr><td>29</td><td>52,5</td><td>21,3</td><td>Therm2</td></tr></tbody></table>	Pin	X	Y	Function	1	52,5	0	DC-In2	2	50,6	7,6	S25	3	47,6	6,2	G25	4	43,8	6,2	Boost-2	5	35,9	0	DC+In2	6	31,3	6,5	Boost+2	7	21,2	6,5	Boost+1	8	16,6	0	DC+In1	9	8,7	6,2	Boost-1	10	4,9	6,2	G15	11	1,9	7,6	S15	12	0	0	DC-In1	13	10,1	21	G17	14	10,1	24	S17	15	0	25,8	DC- Boost1	16	0	28,5	DC- Boost1	17	9,7	28,5	N1	18	12,4	28,5	N1	19	22,1	28,5	DC+Boost	20	24,8	28,5	DC+Boost	21	27,5	28,5	DC+Boost	22	37,1	28,5	N2	23	39,8	28,5	N2	24	39,4	24	S27	25	39,4	21	G27	26	49,5	28,5	DC- Boost2	27	49,5	25,8	DC- Boost2	28	52,5	28,5	Therm1	29	52,5	21,3	Therm2	 <p>Tolerance of pinpositions: ±0.5mm at the end of pins Dimension of coordinate axis is only offset without tolerance</p>			
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Identification

ID	Component	Voltage	Current	Function	Comment
T15, T17, T25, T27	IGBT	1200 V	40 A	Boost Switch	
D15, D17, D25, D27	FWD	1200 V	20 A	Boost Diode	
D45, D47, D55, D57	Rectifier	1600 V	18 A	Boost Sw. Protection Diode	
D16, D18, D26, D28	Rectifier	1600 V	28 A	ByPass Diode	
Rt	Thermistor			Thermistor	

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datasheet

Vincotech**Packaging instruction**

Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow 1 packages see vincotech.com website.

Package data

Package data for flow 1 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-FY12S2A040N3-L868L28-D1-14	16 Oct. 2020		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.